





#### **ULTRA-SMALL SURFACE MOUNT LOW LEAKAGE DIODE**

#### **Features**

- Ultra-Small Leadless Surface Mount Package (0.6 x 0.3mm)
- Ultra-Low Profile Package (0.3mm)
- Very Low Leakage Current
- Low Capacitance
- Ideal for Compact Battery Powered Portable Electronics
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

### **Mechanical Data**

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish Matte Tin Finish over Copper Leadframe
- (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.2mg (Approximate)



Top View



**Bottom View** 

## **Ordering Information** (Note 3)

Part Number	Case	Packaging	
BAS116LP3-7	X3-DFN0603-2	10,000/Tape & Reel	

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
  3. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**

BA

BA = Product Type Marking Code Bar Denotes Cathode Side



## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>R</sub> WM V <sub>R</sub>	85	V	
RMS Reverse Voltage		V <sub>R(RMS)</sub>	60	V	
Forward Continuous Current (Note 4)		I <sub>FM</sub>	215	mA	
Repetitive Peak Forward Current		I <sub>FRM</sub>	500	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I <sub>FSM</sub>	4.0 1.0 0.5	А	

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	$P_{D}$	250	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

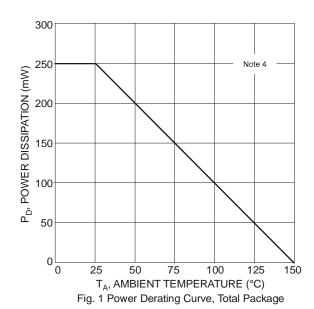
# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

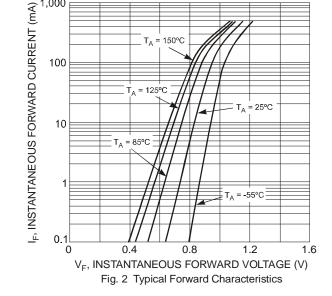
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	85	_	_	V	$I_R = 100 \mu A$
Forward Voltage	V <sub>F</sub>	_	0.75 0.9 1.0 1.15	0.95 1.10 1.20 1.35	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Leakage Current (Note 5)	I <sub>R</sub>		_	10.0 100 500	nA	$V_R = 75V$ $V_R = 1V$ , $T_J = 150$ °C $V_R = 75V$ , $T_J = 150$ °C
Total Capacitance	C <sub>T</sub>		1.6	3.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	120	3000	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

1,000

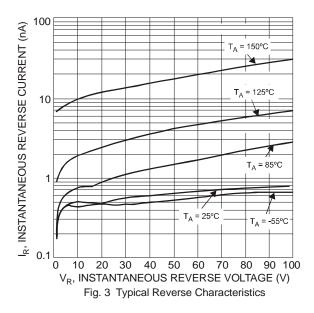
Notes:

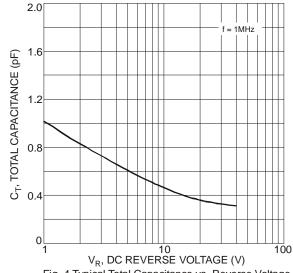
- 4. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.
- 5. Short duration pulse test used to minimize self-heating effect.





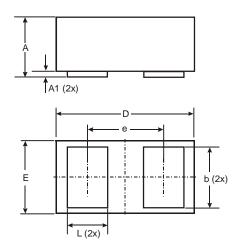






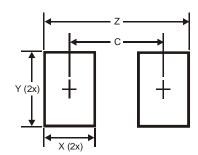
### Fig. 4 Typical Total Capacitance vs. Reverse Voltage

# **Package Outline Dimensions**



X3-DFN0603-2					
Dim	Min	Max	Тур		
Α	0.27	0.35	0.30		
A1	0.00	0.03	0.02		
b	0.19	0.29	0.24		
D	0.595	0.645	0.62		
Е	0.295	0.345	0.32		
е	-	-	0.355		
Ĺ	0.14	0.24	0.19		
All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)
С	0.355
Х	0.230
Υ	0.300
Z	0.610



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